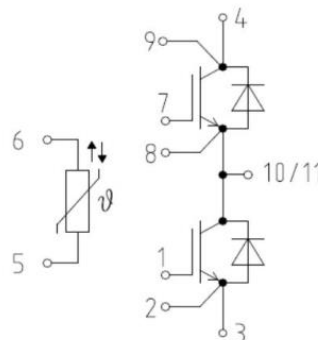


Product Summary

Product Type	V _{CES}	I _C	V _{CE(sat)}	Package
ATGM450N120HBAMW2	1200V	450A	1.60V	EcoDual 3



Features

- Positive temperature coefficient for easy paralleling
- Low losses 1200V IGBT half bridge module
- Low inductive design
- T_{jmax} = 150°C
- Short circuit rated

Typical Applications

- Motor drive
- Servo drive
- UPS / Solar
- Energy storage system

Maximum Ratings (IGBT, T_j=25°C unless otherwise specified)

Parameter	Symbol	Conditions	Value	Unit
Collector-Emitter Voltage	V _{CES}		1200	V
Gate-Emitter Voltage	V _{GES}		±20V	V
DC Continuous Collector Current	I _C	T _C = 100°C	450	A
Pulse Collector Current	I _{CM}	t _p = 1ms	900	A
Maximum Power Dissipation	P _D	T _C = 25°C, T _j = 150°C	2710	W
junction temperature	T _j		-40 to 150	°C
Storage temperature	T _{stg}		-40 to 150	°C

Maximum Ratings (Freewheeling diode, $T_j = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Conditions	Value	Unit
Peak Repetitive Revers Voltage	V_{RRM}		1200	V
Diode forward Current	I_F	$T_C = 100^\circ\text{C}$	450	A
Repetitive peak forward Current	I_{FRM}	$t_p = 1\text{ms}$	900	A
junction temperature	T_j		-40 to 150	$^\circ\text{C}$
Storage temperature	T_{stg}		-40 to 150	$^\circ\text{C}$

Module information

Parameter	Conditions	Value	Unit
Isolation Voltage	RMS, $f = 50\text{Hz}$, $t = 1\text{min}$	3.4	KV
module isolation		Al_2O_3	
CTI		>200	
Stray Inductance Module		20	nH
Module lead resistance, terminals – chip	$T_C = 25^\circ\text{C}$	0.8	m Ω
Mounting torque for module mounting	M5, M6	3 to 5	Nm
Weight		330	g

IGBT Electrical characteristics ($T_j = 25^\circ\text{C}$ unless otherwise specified, chip)

Parameter	Symbol	conditions	Min	Typ	Max	Unit
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C = 450\text{A}$, $V_{GE} = 15\text{V}$	$T_j = 25^\circ\text{C}$	1.65	2.05	V
			$T_j = 150^\circ\text{C}$	2.05		V
Gate-Emitter threshold Voltage	$V_{GE(th)}$	$I_C = 10\text{mA}$, $V_{CE} = V_{GE}$	5.0	5.7	6.6	V
Gate charge	Q_G	$V_{GE} = -15\text{V}$ to $+15\text{V}$		3.3		μC
Internal gate resistor	R_{Gint}	$f = 1\text{MHz}$, $V_{pp} = 1\text{V}$	$T_j = 25^\circ\text{C}$	0.8		Ω
Input Capacitance	C_{ies}	$V_{CE} = 25\text{V}$, $V_{GE} = 0\text{V}$	$T_j = 25^\circ\text{C}$	53		nF
Reverse transfer Capacitance	C_{res}	$f = 100\text{kHz}$		0.5		nF
Collector- Emitter Cut off Current	I_{CES}	$V_{CE} = 1200\text{V}$, $V_{GE} = 0\text{V}$	$T_j = 25^\circ\text{C}$		1	mA
Gate-Emitter Leakage Current	I_{GES}	$V_{CE} = 20\text{V}$, $V_{GE} = 0\text{V}$	$T_j = 25^\circ\text{C}$		500	nA
Turn-on delay time	$t_{d(on)}$	$V_{CE} = 600\text{V}$ $I_C = 450\text{A}$ $V_{GE} = +15\text{V}/-15\text{V}$ $R_G = 1.2\Omega$ Inductive load	$T_j = 25^\circ\text{C}$	120		ns
			$T_j = 150^\circ\text{C}$	130		ns
Rise time	t_r		$T_j = 25^\circ\text{C}$	50		ns
			$T_j = 150^\circ\text{C}$	60		ns
Turn-off delay time	$t_{d(off)}$		$T_j = 25^\circ\text{C}$	400		ns
			$T_j = 150^\circ\text{C}$	450		ns
Fall time	t_f		$T_j = 25^\circ\text{C}$	200		ns
			$T_j = 150^\circ\text{C}$	260		ns
Turn-on power dissipation	E_{on}		$T_j = 25^\circ\text{C}$	20.5		mJ
			$T_j = 150^\circ\text{C}$	38		mJ
Turn-off power dissipation	E_{off}		$T_j = 25^\circ\text{C}$	40		mJ
			$T_j = 150^\circ\text{C}$	52		mJ
Short Circuit	I_{SC}	$V_{GE} = 15\text{V}$, $V_{CC} = 800\text{V}$, $t_p < 10\mu\text{s}$, $T_j = 150^\circ\text{C}$		1450		A

Thermal Resistance, Junction to Case (per IGBT)	$R_{th(j-c)}$			0.055		°C/W
Thermal Resistance, Junction to heatsink (per IGBT)	$R_{th(j-h)}$			0.03		°C/W

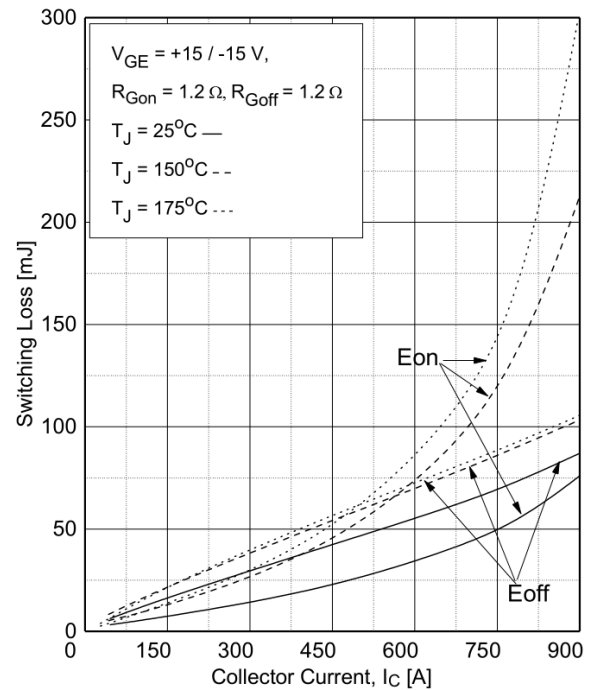
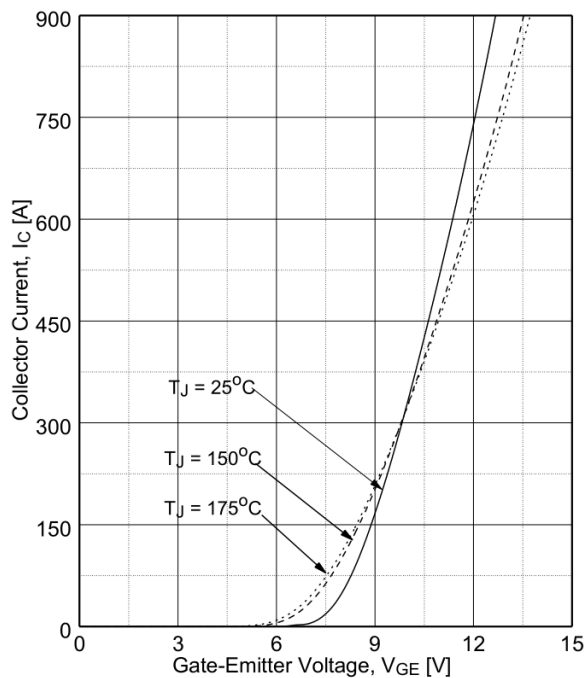
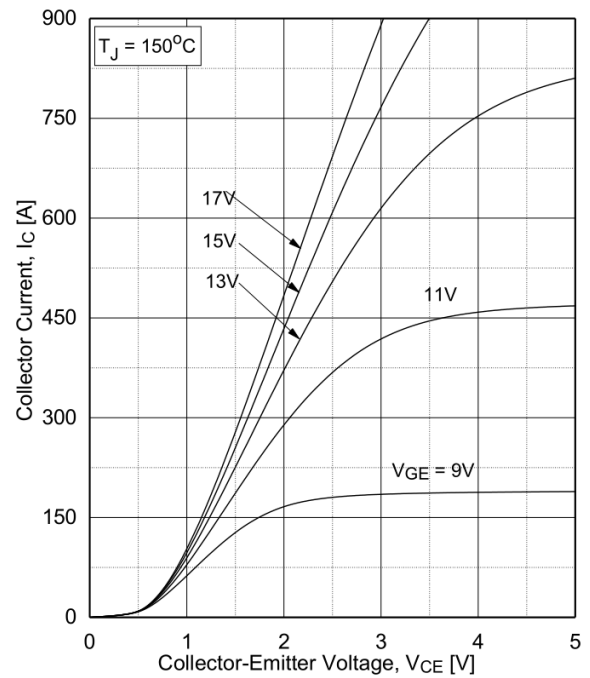
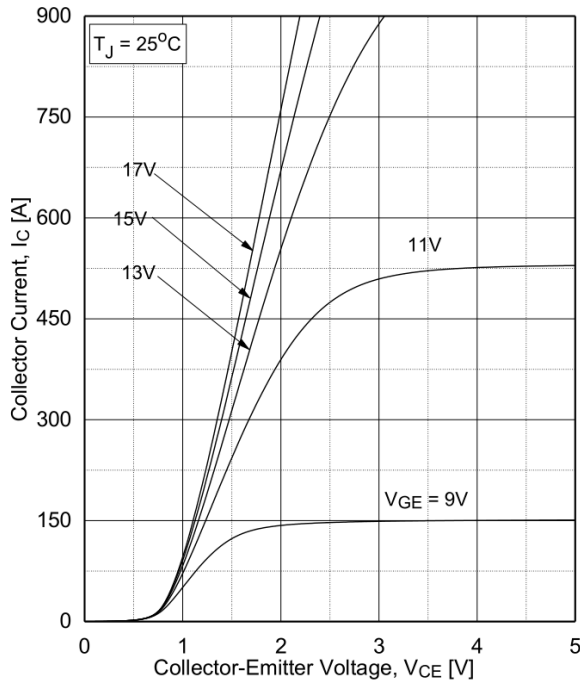
Freewheeling Diode Electrical characteristics (T_j =25°C unless otherwise specified, chip)

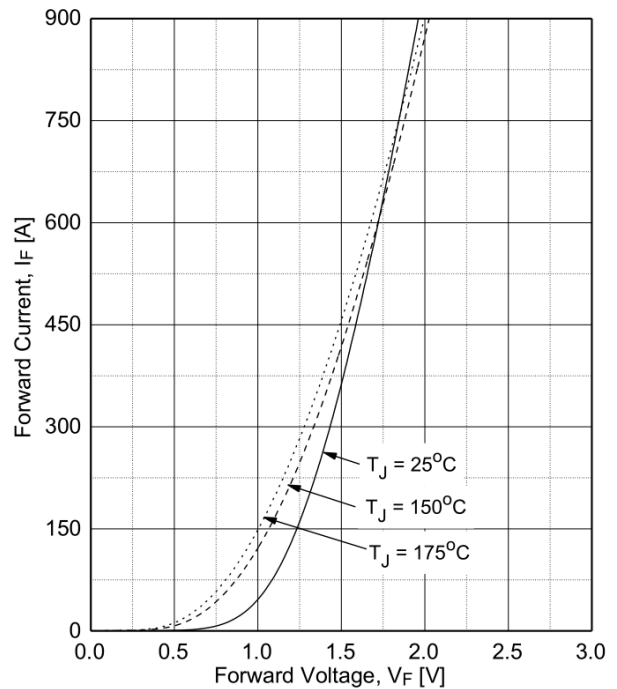
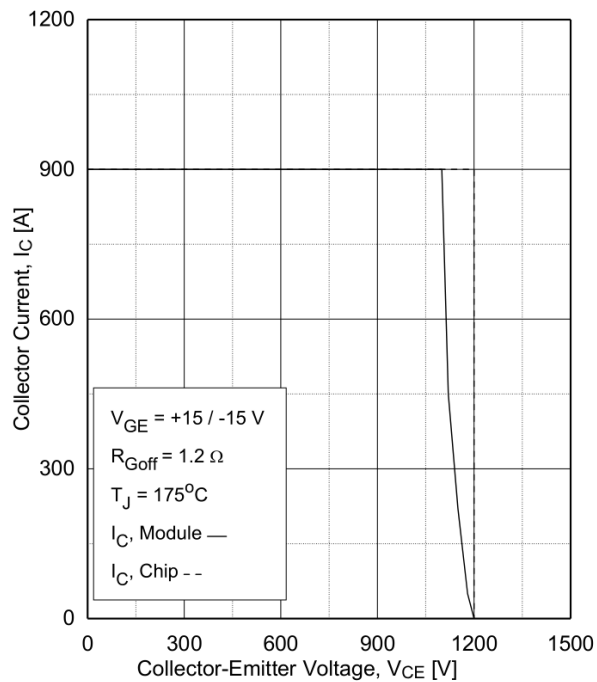
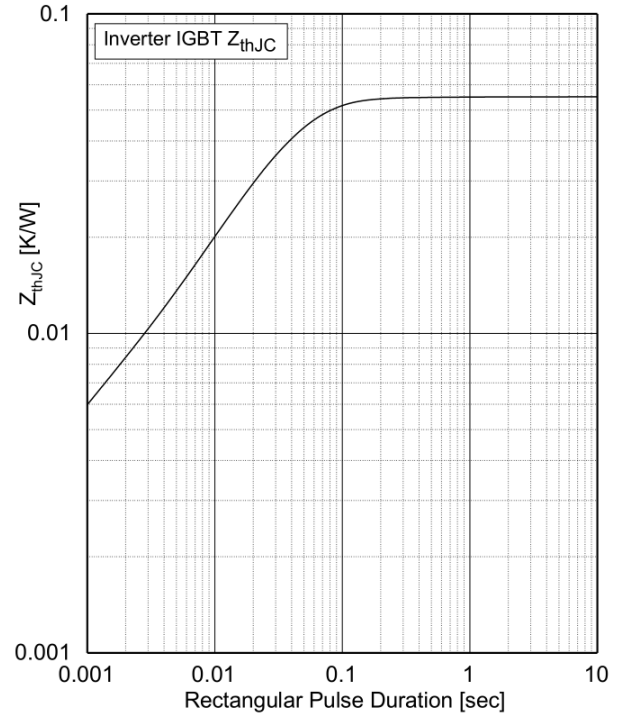
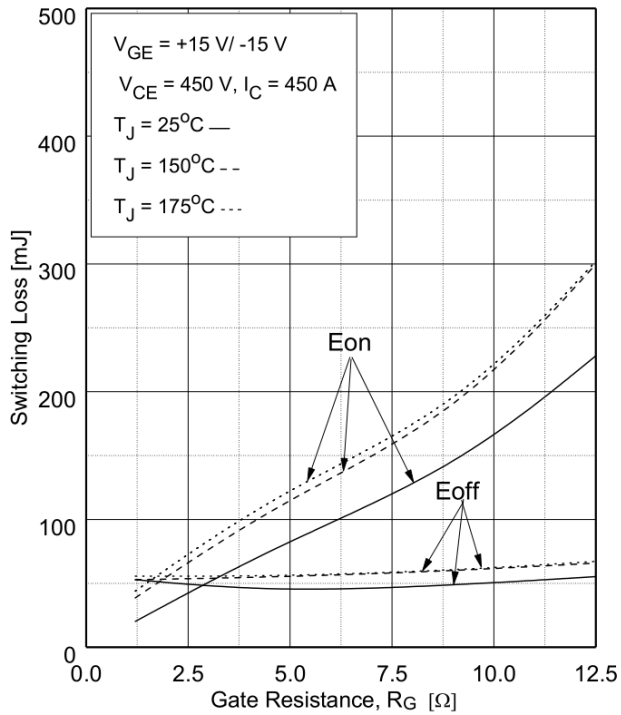
Item	Symbol	Condition		Min.	Typ.	Max.	Unit
Diode Forward Voltage	V_F	$I_F = 450A$, $V_{GE} = 0V$	$T_j = 25\text{ °C}$		1.6	1.95	V
			$T_j = 150\text{ °C}$		1.55		V
Peak reverse recovery Current	I_{rr}	$V_{rr} = 600V$, $I_F = 450A$	$T_j = 25\text{ °C}$		610		A
			$T_j = 150\text{ °C}$		615		A
Recovered charge	Q_{rr}		$T_j = 25\text{ °C}$		75		uC
			$T_j = 150\text{ °C}$		105		uC
Reverse recovered energy	E_{rr}		$T_j = 25\text{ °C}$		35		mJ
			$T_j = 150\text{ °C}$		46		mJ
Thermal Resistance, Junction to Case (per Diode)	$R_{th(j-c)}$				0.08		°C/W
Thermal Resistance, Junction to heatsink (per Diode)	$R_{th(j-h)}$				0.05		°C/W

NTC Electrical characteristics (T_j =25°C unless otherwise specified)

Item	Symbol	Condition		Min.	Typ.	Max.	Unit
Rated resistance	R_{25}	$T_c = 25\text{ °C}$			5		k Ω
Deviation of R_{100}	$\Delta R/R$	$R_{100} = 493\text{ Ω}$	$T_{NTC} = 100\text{ °C}$	-5		5	%
Power dissipation	P_{25}	$T_c = 25\text{ °C}$				20	mW
B-value	$B_{25/50}$	$R_2 = R_{25} \exp [B_{25/50} (1/T_2 - 1/(298.15\text{ K}))]$			3375		

Characteristics Curve:





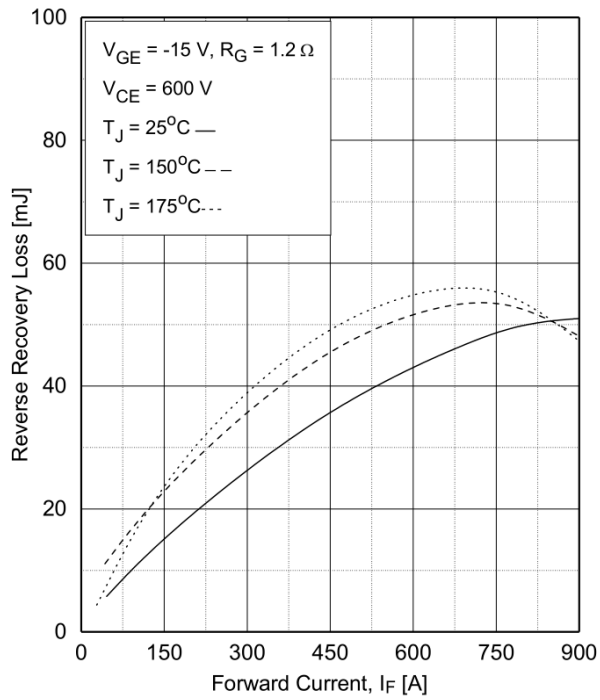


Fig9: Diode Switching loss as I_F

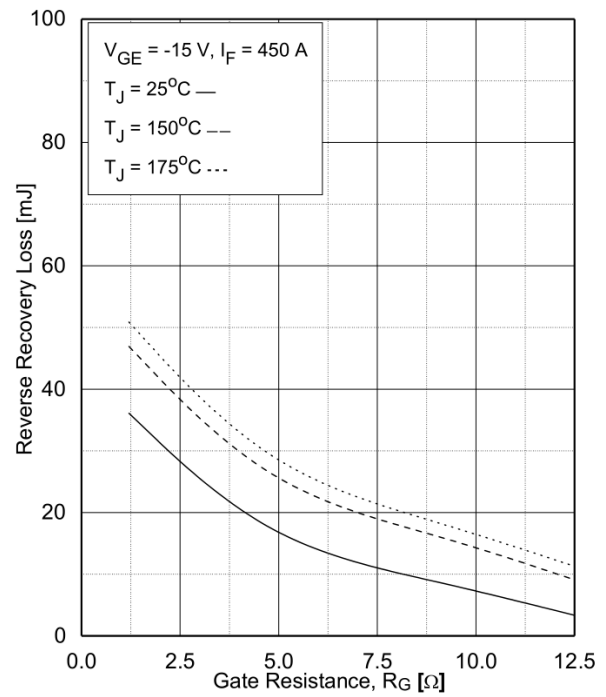


Fig10: Diode switching loss as R_g

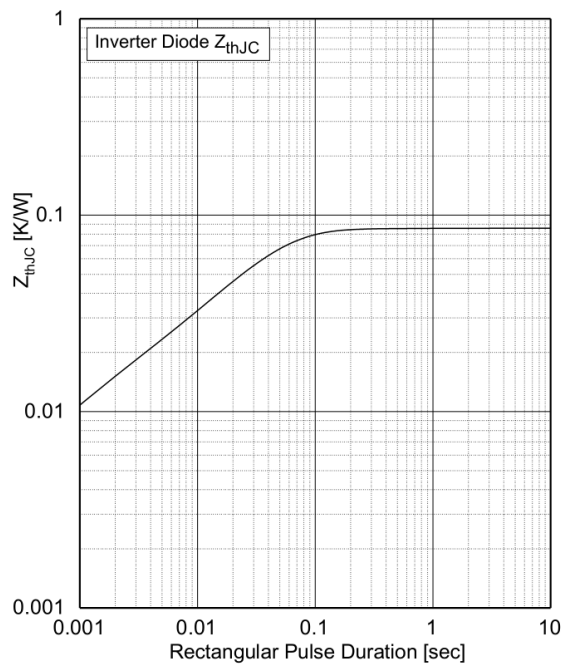


Fig11: Diode Thermal Impedance

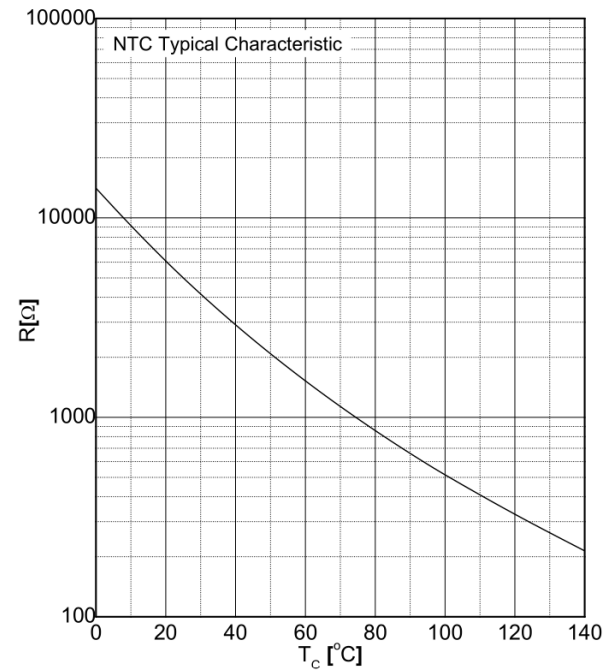
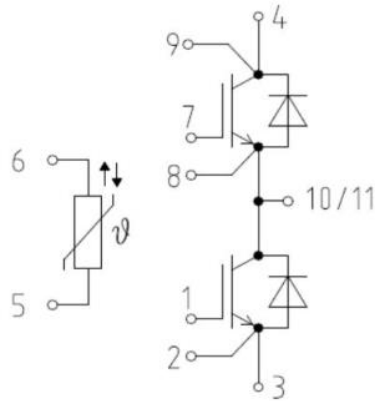


Fig12: NTC Characteristics

Package Information:

EcoDual 3 module



Dimensions in Millimeters

